SDAS002B - MARCH 1984 - REVISED DECEMBER 1994

 Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

#### description

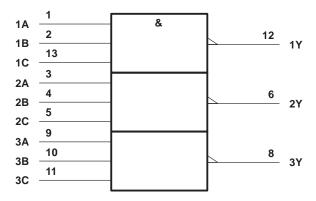
These devices contain three independent 3-input positive-NAND gates. They perform the Boolean functions  $Y = \overline{A} \cdot \overline{B} \cdot \overline{C}$  or  $Y = \overline{A} + \overline{B} + \overline{C}$  in positive logic.

The SN54ALS10A and SN54AS10 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS10A and SN74AS10 are characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each gate)

|   | INPUTS |   | OUTPUT |
|---|--------|---|--------|
| Α | В      | С | Y      |
| Н | Н      | Н | L      |
| L | X      | Χ | Н      |
| Х | L      | Χ | Н      |
| Х | X      | L | Н      |

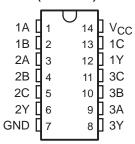
### logic symbol†



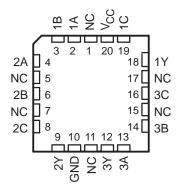
<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, J, and N packages.

#### SN54ALS10A, SN54AS10 . . . J PACKAGE SN74ALS10A, SN74AS10 . . . D OR N PACKAGE (TOP VIEW)

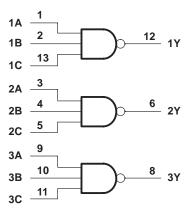


# SN54ALS10A, SN54AS10 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

#### logic diagram (positive logic)



### SN54ALS10A, SN54AS10, SN74ALS10A, SN74AS10 TRIPLE 3-INPUT POSITIVE-NAND GATES

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# absolute maximum ratings over operating free-air temperature range (unless otherwise noted) $\!\!\!\!\!^{\dagger}$

#### recommended operating conditions

|     |                                | SN  | 54ALS1 | 0A   | SN  | 74ALS10 | 0A   |      |
|-----|--------------------------------|-----|--------|------|-----|---------|------|------|
|     |                                | MIN | NOM    | MAX  | MIN | NOM     | MAX  | UNIT |
| Vcc | Supply voltage                 | 4.5 | 5      | 5.5  | 4.5 | 5       | 5.5  | V    |
| VIH | High-level input voltage       | 2   |        |      | 2   |         |      | V    |
| ,,  | Level band Country Warne       |     |        | 0.8‡ |     |         | 0.8  | .,   |
| VIL | Low-level input voltage        |     |        | 0.7§ |     |         |      | V    |
| ІОН | High-level output current      |     |        | -0.4 |     |         | -0.4 | mA   |
| lOL | Low-level output current       |     |        | 4    |     |         | 8    | mA   |
| TA  | Operating free-air temperature | -55 |        | 125  | 0   |         | 70   | °C   |

<sup>‡</sup> Applies over temperature range -55°C to 70°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETED        | TEOT 0                                      | SN5                        | 4ALS1              | )A   | SN   | 74ALS10            | )A   | LINIT |    |
|------------------|---|----------------------------|--------------------|------|------|--------------------|------|-------|----|
| PARAMETER        | TEST Co                                     | MIN                        | TYP¶               | MAX  | MIN  | TYP¶               | MAX  | UNIT  |    |
| VIK              | V <sub>CC</sub> = 4.5 V,                    | I <sub>I</sub> = -18 mA    |                    |      | -1.5 |                    |      | -1.5  | V  |
| Voн              | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$ | $I_{OH} = -0.4 \text{ mA}$ | V <sub>CC</sub> -2 |      |      | V <sub>CC</sub> -2 | )    |       | V  |
| V                | V 45V                                       | I <sub>OL</sub> = 4 mA     |                    | 0.25 | 0.4  |                    | 0.25 | 0.4   | V  |
| VOL              | V <sub>CC</sub> = 4.5 V                     | I <sub>OL</sub> = 8 mA     |                    |      |      |                    | 0.35 | 0.5   | V  |
| lį               | $V_{CC} = 5.5 \text{ V},$                   | V <sub>I</sub> = 7 V       |                    |      | 0.1  |                    |      | 0.1   | mA |
| lіН              | $V_{CC} = 5.5 \text{ V},$                   | $V_{I} = 2.7 \ V$          |                    |      | 20   |                    |      | 20    | μΑ |
| I <sub>IL</sub>  | V <sub>CC</sub> = 5.5 V,                    | V <sub>I</sub> = 0.4 V     |                    |      | -0.1 |                    |      | -0.1  | mA |
| I <sub>O</sub> # | $V_{CC} = 5.5 \text{ V},$                   | V <sub>O</sub> = 2.25 V    | -20                |      | -112 | -30                |      | -112  | mA |
| Іссн             | $V_{CC} = 5.5 \text{ V},$                   | V <sub>I</sub> = 0         |                    | 0.32 | 0.6  |                    | 0.32 | 0.6   | mA |
| <sup>I</sup> CCL | V <sub>CC</sub> = 5.5 V,                    | V <sub>I</sub> = 4.5 V     |                    | 1.2  | 2.2  |                    | 1.2  | 2.2   | mA |

<sup>¶</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>§</sup> Applies over temperature range 70°C to 125°C

<sup>#</sup>The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

### SN54ALS10A, SN54AS10, SN74ALS10A, SN74AS10 TRIPLE 3-INPUT POSITIVE-NAND GATES

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#### switching characteristics (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>C</sub><br>C <sub>L</sub><br>R <sub>L</sub><br>T <sub>A</sub> | UNIT |               |     |    |
|------------------|-----------------|----------------|--|------|---------------|-----|----|
|                  |                 |                | SN54AI<br>MIN  | MAX  | SN74AI<br>MIN | MAX |    |
| <sup>t</sup> PLH | A P or C        | V              | 2  | 12   | 2             | 11  | 20 |
| <sup>t</sup> PHL | A, B, or C      | 1              | 2  | 12   | 2             | 10  | ns |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

| Supply voltage, V <sub>CC</sub>                                 |                |
|---|----------------|
| Input voltage, V <sub>I</sub>                                   |                |
| Operating free-air temperature range, T <sub>A</sub> : SN54AS10 | –55°C to 125°C |
| SN74AS10  | 0°C to 70°C    |
| Storage temperature range                                       | –65°C to 150°C |

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions

|          |                                | S   | N54AS1 | 0   | S   | N74AS1 | 0   |      |
|----------|--------------------------------|-----|--------|-----|-----|--------|-----|------|
|          |                                | MIN | NOM    | MAX | MIN | NOM    | MAX | UNIT |
| VCC      | Supply voltage                 | 4.5 | 5      | 5.5 | 4.5 | 5      | 5.5 | V    |
| VIH      | High-level input voltage       | 2   |        |     | 2   |        |     | V    |
| $V_{IL}$ | Low-level input voltage        |     |        | 8.0 |     |        | 8.0 | V    |
| IOH      | High-level output current      |     |        | -2  |     |        | -2  | mA   |
| lOL      | Low-level output current       |     |        | 20  |     |        | 20  | mA   |
| TA       | Operating free-air temperature | -55 |        | 125 | 0   |        | 70  | °C   |

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                  |   | TEST CONDITIONS -        |                    |      |      |                    | N74AS1 | 0    | LINUT |
|------------------|---|--------------------------|--------------------|------|------|--------------------|--------|------|-------|
| PARAMETER        | TEST CO                                     |                          |                    |      |      |                    | TYP§   | MAX  | UNIT  |
| VIK              | $V_{CC} = 4.5 \text{ V},$                   | I <sub>I</sub> = -18 mA  |                    |      | -1.2 |                    |        | -1.2 | V     |
| Voн              | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$ | $I_{OH} = -2 \text{ mA}$ | V <sub>CC</sub> -2 |      |      | V <sub>CC</sub> -2 |        |      | V     |
| VOL              | $V_{CC} = 4.5 \text{ V},$                   | $I_{OL} = 20 \text{ mA}$ |                    | 0.35 | 0.5  |                    | 0.35   | 0.5  | V     |
| lį               | V <sub>CC</sub> = 5.5 V,                    | V <sub>I</sub> = 7 V     |                    |      | 0.1  |                    |        | 0.1  | mA    |
| l <sub>IH</sub>  | $V_{CC} = 5.5 V,$                           | V <sub>I</sub> = 2.7 V   |                    |      | 20   |                    |        | 20   | μΑ    |
| I <sub>IL</sub>  | V <sub>CC</sub> = 5.5 V,                    | V <sub>I</sub> = 0.4 V   |                    |      | -0.5 |                    |        | -0.5 | mA    |
| IO¶              | V <sub>CC</sub> = 5.5 V,                    | V <sub>O</sub> = 2.25 V  | -30                |      | -112 | -30                |        | -112 | mA    |
| ICCH             | V <sub>CC</sub> = 5.5 V,                    | V <sub>I</sub> = 0       |                    | 1.5  | 2.4  |                    | 1.5    | 2.4  | mA    |
| <sup>I</sup> CCL | V <sub>CC</sub> = 5.5 V,                    | V <sub>I</sub> = 4.5 V   |                    | 8.1  | 13   |                    | 8.1    | 13   | mA    |

<sup>§</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .



The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

### SN54ALS10A, SN54AS10, SN74ALS10A, SN74AS10 TRIPLE 3-INPUT POSITIVE-NAND GATES

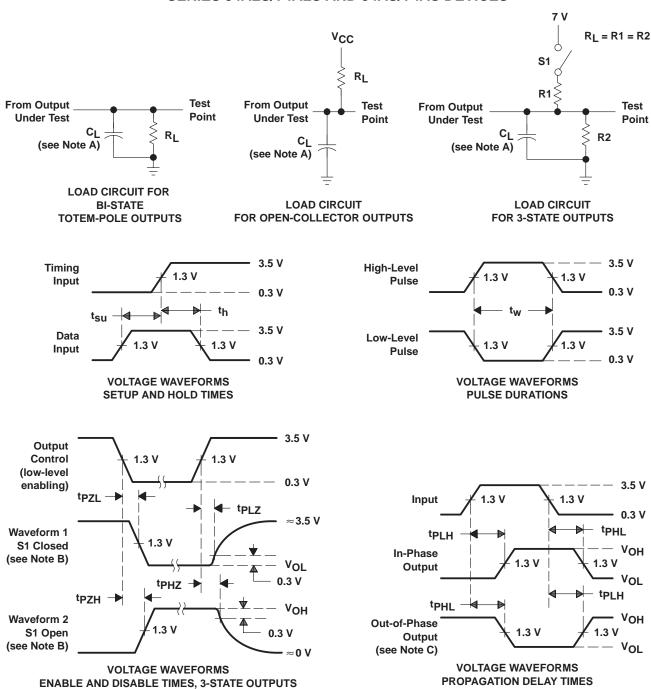
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#### switching characteristics (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | ТО<br>(ОИТРИТ) | C <sub>L</sub><br>R <sub>L</sub><br>T <sub>A</sub> | = 50 pF<br>= 500 Ω<br>= MIN t | o MAX† |      | UNIT |
|------------------|-----------------|----------------|--|-------------------------------|--------|------|------|
|                  |                 |                | SN54   | AS10                          | SN74/  | AS10 |      |
|                  |                 |                | MIN  | MAX                           | MIN    | MAX  |      |
| tPLH             | A, B, or C      | V              | 1  | 5                             | 1      | 4.5  | 20   |
| <sup>t</sup> PHL | А, Б, 01 С      | ſ              | 1  | 5                             | 1      | 4.5  | ns   |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

#### PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics:  $PRR \le 1$  MHz,  $t_r = t_f = 2$  ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms







25-Sep-2013

#### **PACKAGING INFORMATION**

| Orderable Device | Status | Package Type | -       | Pins | -    | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | <b>Device Marking</b>                   | Samples |
|------------------|--------|--------------|---------|------|------|----------------------------|------------------|--------------------|--------------|---|---------|
|                  | (1)    |              | Drawing |      | Qty  | (2)                        |                  | (3)                |              | (4/5)                                   |         |
| 5962-86865012A   | ACTIVE | LCCC         | FK      | 20   | 1    | TBD                        | POST-PLATE       | N / A for Pkg Type | -55 to 125   | 5962-<br>86865012A<br>SNJ54ALS<br>10AFK | Samples |
| 5962-8686501CA   | ACTIVE | CDIP         | J       | 14   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | 5962-8686501CA<br>SNJ54ALS10AJ          | Samples |
| 5962-8686501DA   | ACTIVE | CFP          | W       | 14   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | 5962-8686501DA<br>SNJ54ALS10AW          | Samples |
| JM38510/37002B2A | ACTIVE | LCCC         | FK      | 20   | 1    | TBD                        | POST-PLATE       | N / A for Pkg Type | -55 to 125   | JM38510/<br>37002B2A                    | Samples |
| JM38510/37002BCA | ACTIVE | CDIP         | J       | 14   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | JM38510/<br>37002BCA                    | Samples |
| M38510/37002B2A  | ACTIVE | LCCC         | FK      | 20   | 1    | TBD                        | POST-PLATE       | N / A for Pkg Type | -55 to 125   | JM38510/<br>37002B2A                    | Samples |
| M38510/37002BCA  | ACTIVE | CDIP         | J       | 14   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | JM38510/<br>37002BCA                    | Samples |
| SN54ALS10AJ      | ACTIVE | CDIP         | J       | 14   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | SN54ALS10AJ                             | Samples |
| SN54AS10J        | ACTIVE | CDIP         | J       | 14   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | SN54AS10J                               | Samples |
| SN74ALS10AD      | ACTIVE | SOIC         | D       | 14   | 50   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | ALS10A                                  | Samples |
| SN74ALS10ADE4    | ACTIVE | SOIC         | D       | 14   | 50   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | ALS10A                                  | Samples |
| SN74ALS10ADG4    | ACTIVE | SOIC         | D       | 14   | 50   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | ALS10A                                  | Samples |
| SN74ALS10ADR     | ACTIVE | SOIC         | D       | 14   | 2500 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | ALS10A                                  | Samples |
| SN74ALS10ADRE4   | ACTIVE | SOIC         | D       | 14   | 2500 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | ALS10A                                  | Samples |
| SN74ALS10ADRG4   | ACTIVE | SOIC         | D       | 14   | 2500 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | ALS10A                                  | Samples |
| SN74ALS10AN      | ACTIVE | PDIP         | N       | 14   | 25   | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | 0 to 70      | SN74ALS10AN                             | Samples |



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| Orderable Device | Status   | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking (4/5)                    | Samp |
|------------------|----------|--------------|--------------------|------|----------------|----------------------------|------------------|--------------------|--------------|---|------|
| SN74ALS10ANE4    | ACTIVE   | PDIP         | N                  | 14   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | 0 to 70      | SN74ALS10AN                             | Samp |
| SN74ALS10ANSR    | ACTIVE   | SO           | NS                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | ALS10A                                  | Samp |
| SN74ALS10ANSRE4  | ACTIVE   | so           | NS                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | ALS10A                                  | Samp |
| SN74ALS10ANSRG4  | ACTIVE   | SO           | NS                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | ALS10A                                  | Samp |
| SN74AS10D        | ACTIVE   | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | AS10                                    | Samp |
| SN74AS10DE4      | ACTIVE   | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | AS10                                    | Sam  |
| SN74AS10DG4      | ACTIVE   | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | AS10                                    | Sam  |
| SN74AS10DR       | ACTIVE   | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | AS10                                    | Sam  |
| SN74AS10DRE4     | ACTIVE   | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | AS10                                    | Sam  |
| SN74AS10DRG4     | ACTIVE   | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | AS10                                    | Sam  |
| SN74AS10N        | ACTIVE   | PDIP         | N                  | 14   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | 0 to 70      | SN74AS10N                               | Sam  |
| SN74AS10N3       | OBSOLETI | PDIP         | N                  | 14   |                | TBD                        | Call TI          | Call TI            | 0 to 70      |   |      |
| SN74AS10NE4      | ACTIVE   | PDIP         | N                  | 14   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | 0 to 70      | SN74AS10N                               | Sam  |
| SN74AS10NSR      | ACTIVE   | SO           | NS                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | 74AS10                                  | Sam  |
| SN74AS10NSRE4    | ACTIVE   | SO           | NS                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | 74AS10                                  | Sam  |
| SN74AS10NSRG4    | ACTIVE   | SO           | NS                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | 74AS10                                  | Sam  |
| SNJ54ALS10AFK    | ACTIVE   | LCCC         | FK                 | 20   | 1              | TBD                        | POST-PLATE       | N / A for Pkg Type | -55 to 125   | 5962-<br>86865012A<br>SNJ54ALS<br>10AFK | Sam  |
| SNJ54ALS10AJ     | ACTIVE   | CDIP         | J                  | 14   | 1              | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | 5962-8686501CA                          | Sam  |



#### PACKAGE OPTION ADDENDUM

25-Sep-2013

| Orderable Device | Status | Package Type |         | Pins | Package | Eco Plan | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking                 | Samples |
|------------------|--------|--------------|---------|------|---------|----------|------------------|--------------------|--------------|--------------------------------|---------|
|                  | (1)    |              | Drawing |      | Qty     | (2)      |                  | (3)                |              | (4/5)                          |         |
|                  |        |              |         |      |         |          |                  |                    |              | SNJ54ALS10AJ                   |         |
| SNJ54ALS10AW     | ACTIVE | CFP          | W       | 14   | 1       | TBD      | A42              | N / A for Pkg Type | -55 to 125   | 5962-8686501DA<br>SNJ54ALS10AW | Samples |
| SNJ54AS10FK      | ACTIVE | LCCC         | FK      | 20   | 1       | TBD      | POST-PLATE       | N / A for Pkg Type | -55 to 125   | SNJ54AS<br>10FK                | Samples |
| SNJ54AS10J       | ACTIVE | CDIP         | J       | 14   | 1       | TBD      | A42              | N / A for Pkg Type | -55 to 125   | SNJ54AS10J                     | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

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25-Sep-2013

#### OTHER QUALIFIED VERSIONS OF SN54ALS10A, SN54AS10, SN74ALS10A, SN74AS10:

• Catalog: SN74ALS10A, SN74AS10

• Military: SN54ALS10A, SN54AS10

NOTE: Qualified Version Definitions:

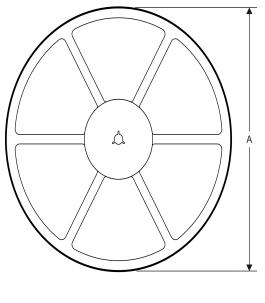
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

### PACKAGE MATERIALS INFORMATION

14-Jul-2012 www.ti.com

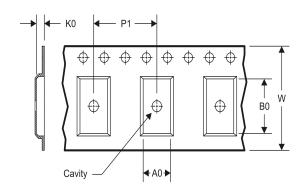
#### TAPE AND REEL INFORMATION

#### **REEL DIMENSIONS**





#### **TAPE DIMENSIONS**



| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### TAPE AND REEL INFORMATION

\*All dimensions are nominal

| All differsions are norminal |                 |                    |    |      |                          |                          |            |            |            |            |           |                  |
|------------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                       | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| SN74ALS10ADR                 | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74ALS10ANSR                | SO              | NS                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |
| SN74AS10DR                   | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74AS10NSR                  | SO              | NS                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |

**PACKAGE MATERIALS INFORMATION** 

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\*All dimensions are nominal

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|---------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device                          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
| SN74ALS10ADR                    | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| SN74ALS10ANSR                   | so           | NS              | 14   | 2000 | 367.0       | 367.0      | 38.0        |
| SN74AS10DR                      | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| SN74AS10NSR                     | SO           | NS              | 14   | 2000 | 367.0       | 367.0      | 38.0        |

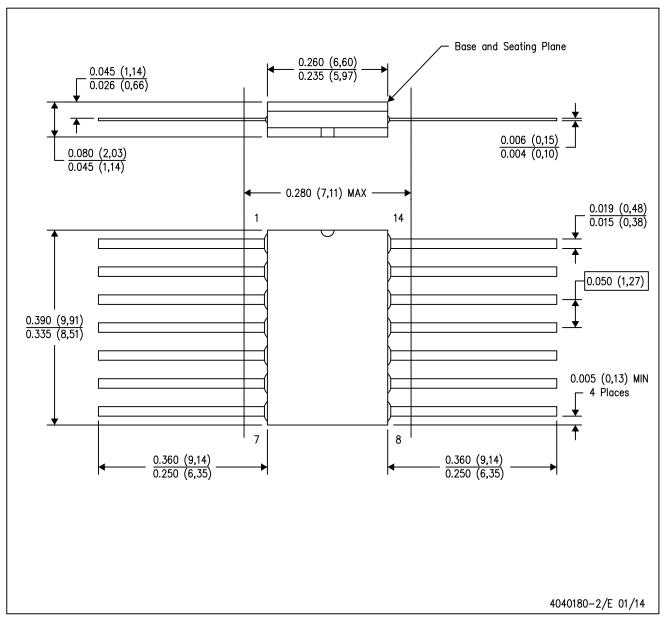
### 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## W (R-GDFP-F14)

### CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



### FK (S-CQCC-N\*\*)

### LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



### N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



### D (R-PDSO-G14)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



# D (R-PDSO-G14)

### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



#### **MECHANICAL DATA**

### NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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